

Application No. 10/606,525  
SD-7139.1

### AMENDMENT TO THE SPECIFICATION

- Please replace the paragraph starting at p. 14, line 1, with the following:

Certain embodiments of the present invention may use a range of protective coatings as thin encapsulants, including Parylene, SU-8, sputtered films, sprayed materials, and globbed or dabbed or dispensed materials (i.e., "goo" refers to a material that dries or cures). The thin, electrically-insulating, protective coating can be selected from: a vapor-deposited coating, —a— vacuum vapor deposited coating, a chemical vapor deposited coating, a water-insoluble coating, a water-soluble coating, a dry-etchable coating, a conformal coating, a pin-hole free coating, parylene, a photopatternable/photoimagable material, photoresist, low viscosity photoresist, an epoxy based negative photoresist, SU-8, SU-8 2000, sputtered coating, an evaporated coating, a ceramic coating, silicon nitride, aluminum oxide, mullite), sprayed coating, a self-assembled monolayered material, cyanoacrylate, perfluoropolyether, hexamethyldisilazane, perfluorodecanoic carboxylic acid, silicon dioxide, TEOS, silicate glass, fast-etch glass, silicon, polysilicon. Some of these coating materials resist attack by acids (e.g., HF, HCL) used in wet release steps.